



Product Change Notification

113991 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113991 - 00
Change Title: Intel® NUC Board NUC5i5MYBE and Intel® NUC Kit NUC5i5MYHE, PCN 113991-00, Product Design, Label, Product Material, BIOS Update for board and Adapter changes and Label
Date of Publication: July 24, 2015

Key Characteristics of the Change:

Product Design, Label, Product Material

Forecasted Key Milestones:






Date Customer Must be Ready to Receive Post-Conversion Material:	Aug 24, 2015
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Description of Change to the Customer:

The Intel® NUC products listed in the products affected table below will have the following changes.

1. Board
 - The BIOS will be updated from MYi50018 to MYI50024. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.
2. Adapter
 - Add BIS certificate label on the FSP power adapter to support shipments to India.
 - Add India adapter.
 - Change plug orientation of Australia adapter
 - Add barcode on the accessories to enhance the factory process

Example pictures:

Item	Before	After
India BIS Label Placement		
India Adapter	<p>NA</p>	
Australia Adapter		

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS to ensure a smooth transition. This change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers. Intel validation of a new board revision does not include testing with older versions of BIOS.

The change for the power brick is only for enabling the use of the power brick in India.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BLKNUC5I5MYHE	938688	H47796-203	H47797-203	H47796-204	H47797-204
BLKNUC5I5MYBE	938713		H47797-203		H47797-204

PCN Revision History:

Date of Revision:

July 24, 2015

Revision Number:

00

Reason:

Originally Published PCN